Product data sheet

1. General description

Passivated, sensitive gate thyristors in a plastic envelope, intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

2. Features and benefits

- High blocking voltage suitable for high voltage applications
- Sensitive gate suitable for logic level controls

3. Applications

General purpose switching

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage			-	-	800	V
$I_{T(AV)}$	average on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 1</u>		-	-	5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 2; Fig. 3</u>		-	-	8	Α
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)} = 25 ^{\circ}\text{C}$; $t_p = 10 \text{ms}$; Fig. 4; Fig. 5		-	-	75	А
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms		-	-	82	Α
T _j	junction temperature		[1]	-	-	125	°C
Static ch	aracteristics						
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 7$		-	50	200	mA
Dynamic	characteristics						
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T_{j} = 125 °C; R_{GK} = 100 Ω; $(V_{DM}$ = 67% of V_{DRM}); exponential waveform; Fig. 12		50	100	-	V/µs

^[1] Operation above 110°C may require the use of a gate to cathode resistor of $1k\Omega$ or less.

Logic level thyristor

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	mb	
2	А	anode	}	A K G
3	G	gate		sym037
mb	A	mounting base; connected to anode		

6. Ordering information

Table 3. Ordering information

Type number	Package name	Orderable part number	Packing method	Small packing quantity	Package version	Package issue date
BT258-800R	TO220	BT258-800R,127	Tube	50	SOT78	13-Jun-2008

7. Marking

Table 4. Marking codes

Type number	Marking codes			
	Assembly factory: d	Assembly factory: A		
BT258-800R	BT258 800R PJdxxxx xx	BT258 800R PJAxxxx xx		

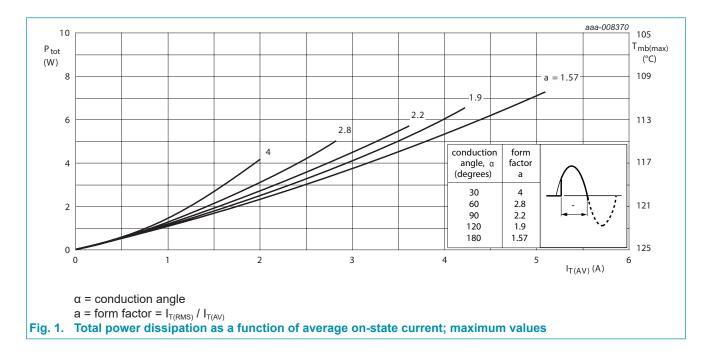
8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage			-	800	V
V_{RRM}	repetitive peak reverse voltage			-	800	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 1</u>		-	5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 2</u> ; <u>Fig. 3</u>		-	8	Α
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5		-	75	А
		half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms		-	82	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN		-	28	A ² s
dl _⊤ /dt	rate of rise of on-state current	$I_T = 10 \text{ A}; I_G = 50 \text{ mA}; dI_G/dt = 50 \text{ mA/}\mu\text{s}$		-	50	A/µs
I _{GM}	peak gate current			-	2	А
V_{RGM}	peak reverse gate voltage			-	5	V
P_{GM}	peak gate power			-	5	W
$P_{G(AV)}$	average gate power	over any 20 ms period		-	0.5	W
T _{stg}	storage temperature			-40	150	°C
T _j	junction temperature		[1]	-	125	°C

[1] Operation above 110°C may require the use of a gate to cathode resistor of $1k\Omega$ or less.



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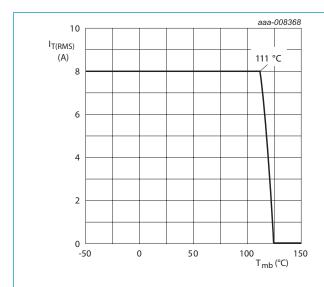
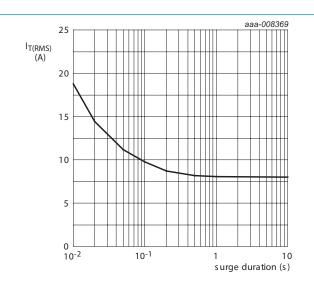
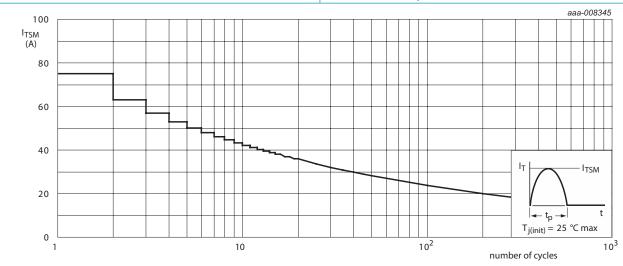


Fig. 2. RMS on-state current as a function of mounting base temperature; maximum values



f = 50 Hz; T_{mb} =111 °C Fig. 3. RMS on-state current as a function of surge duration; maximum values

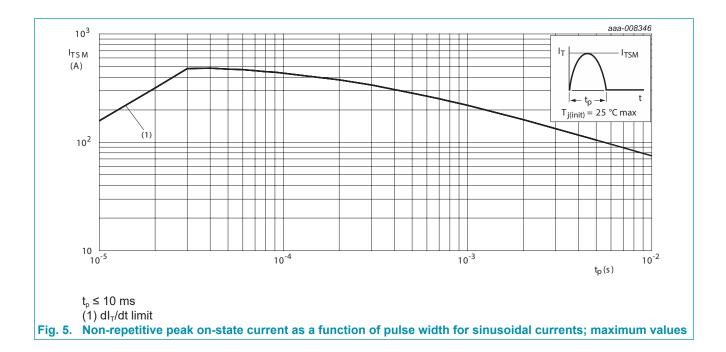


f = 50 Hz

Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	Fig. 6	-	-	2	K/W
$R_{th(j-a)}$	thermal resistance from junction to ambient free air	in free air	-	60	-	K/W

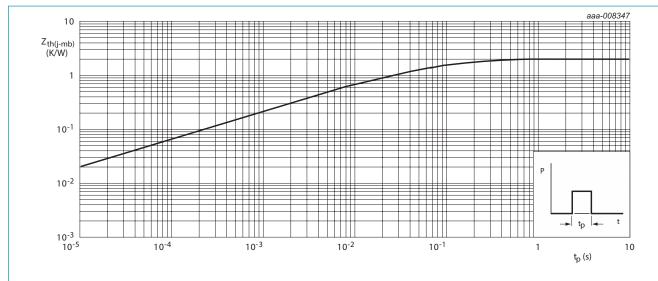


Fig. 6. Transient thermal impedance from junction to mounting base as a function of pulse width

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; I_T = 0.1 \text{ A}; T_j = 25 \text{ °C}; Fig. 7$	-	50	200	mA
IL	latching current	$V_D = 12 \text{ V}; I_G = 0.1 \text{ A}; T_j = 25 ^{\circ}\text{C}; Fig. 8$	-	0.4	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	0.4	6	mA
V _T	on-state voltage	I _T = 16 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
V_{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A;T _j = 25 °C; <u>Fig. 11</u>	-	0.4	1	V
		V _D = 800V; I _T = 0.1 A;T _j = 110 °C	0.1	0.2	-	V
I _D	off-state current	V _D = 800 V; T _j = 125 °C	-	0.1	0.5	mA
I _R	reverse current	V _R = 800 V; T _j = 125 °C	-	0.1	0.5	mA
Dynamic	characteristics		,			
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 536 V; T_j = 125 °C; R_{GK} = 100 Ω; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12	50	100	-	V/µs
t _{gt}	gate-controlled turn-on time	$I_{TM} = 10 \text{ A}; V_D = 800 \text{ V}; I_G = 5 \text{ mA};$ $dI_G/dt = 0.2 \text{ A/}\mu\text{s}; T_j = 25 ^{\circ}\text{C}$	-	2	-	μs
t _q	commutated turn-off time	$V_{DM} = 536 \text{ V}; T_j = 125 \text{ °C}; I_{TM} = 12 \text{ A}; V_R = 24 \text{ V}; (dI_T/dt)_M = 10 \text{ A/µs; } dV_D/dt = 2 \text{ V/µs;} R_{GK(ext)} = 1 \text{ k}\Omega; (V_{DM} = 67\% \text{ of } V_{DRM})$	-	100	-	μs

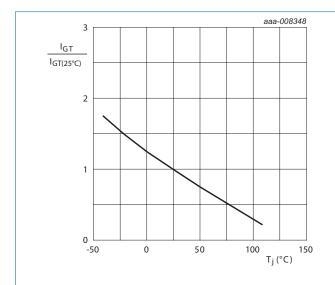


Fig. 7. Normalized gate trigger current as a function of junction temperature

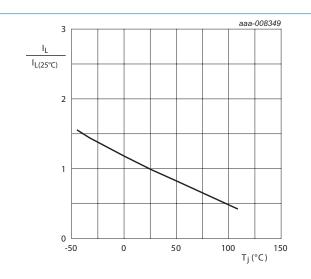


Fig. 8. Normalized latching current as a function of junction temperature

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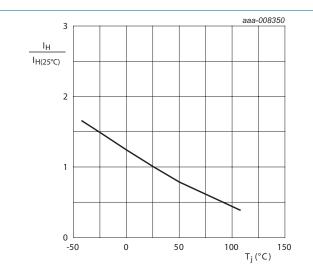
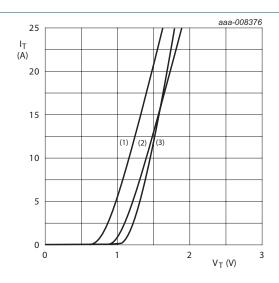


Fig. 9. Normalized holding current as a function of junction temperature



 V_0 = 1.0 V; R_s = 0.04 Ω (1) T_j = 125 °C; typical values (2) T_j = 125 °C; maximum values (3) T_j = 25 °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

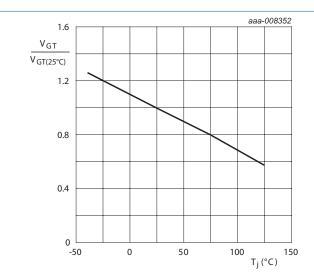
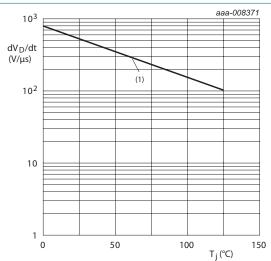


Fig. 11. Normalized gate trigger voltage as a function of junction temperature



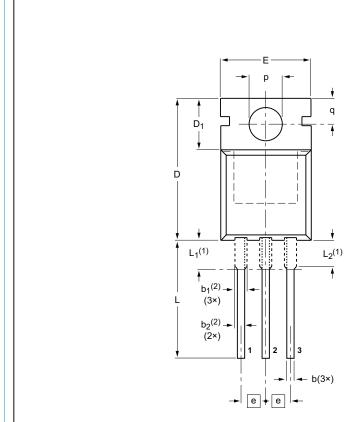
(1) $R_{GK} = 100 \Omega$

Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

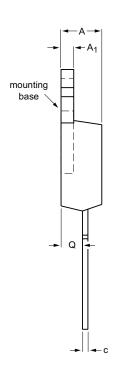
SOT78

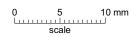
11. Package outline

Assembly factory: d & A



Plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB





DIMENSIONS (mm are the original dimensions)

		•		-		•										
UNIT	Α	A ₁	b	b ₁ ⁽²⁾	b ₂ (2)	С	D	D ₁	E	е	L	L ₁ (1)	L ₂ ⁽¹⁾ max.	р	q	Q
mm	4.7 4.1	1.40 1.25	0.9 0.6	1.6 1.0	1.3 1.0	0.7 0.4	16.0 15.2	6.6 5.9	10.3 9.7	2.54	15.0 12.8	3.30 2.79	3.0	3.8 3.5	3.0 2.7	2.6 2.2

Notes

- Lead shoulder designs may vary.
 Dimension includes excess dambar.

OUTLINE		REFER	ENCES		EUROPEAN PROJECTION	ISSUE DATE
VERSION	IEC	JEDEC	JEITA			ISSUE DATE
SOT78		3-lead TO-220AB	SC-46			08-04-23 08-06-13

BT258-800R

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Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
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